

# MOS FIELD EFFECT TRANSISTOR **2SK3061**

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

This product is N-Channel MOS Field Effect Transistor designed for high current switching application.

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE		
2SK3061	Isolated TO-220		

#### **FEATURES**

· Low on-state resistance

 $R_{DS(on)1} = 8.5 \text{ m}\Omega$  MAX. (Vgs = 10 V, ID = 35 A)

 $R_{DS(on)2} = 12 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = 4.0 \text{ V, ID} = 35 \text{ A)}$ 

- Low Ciss: Ciss = 5200 pF TYP.
- Built-in gate protection diode
- Isolated TO-220 package

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage	VDSS	60	V
Gate to Source Voltage	VGSS(AC)	±20	V
Gate to Source Voltage	VGSS(DC)	+20, -10	V
Drain Current (DC)	ID(DC)	±70	Α
Drain Current (pulse) Note1	D(pulse)	±280	Α
Total Power Dissipation (Tc = 25°C)	Рт	35	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	35	Α
Single Avalanche Energy Note2	Eas	122.5	mJ

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %

2. Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V $\rightarrow$ 0 V

#### THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	3.57	°C/W	
Channel to Ambient	Rth(ch-A)	62.5	°C/W	

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

90%

90%

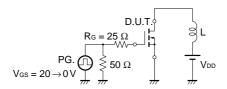
-10%

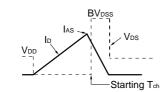


### **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

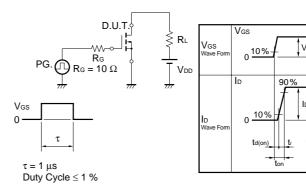
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 35 A		6.3	8.5	mΩ
	RDS(on)2	Vgs = 4.0 V, ID = 35 A		8.2	12	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.0	1.5	2.0	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 35 A	20	87		S
Drain Leakage Current	IDSS	Vps = 60 V, Vgs = 0 V			10	μΑ
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 20  V,  V_{DS} = 0  V$			±10	μΑ
Input Capacitance	Ciss	Vps = 10 V		5200		pF
Output Capacitance	Coss	Vgs = 0 V		1300		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		480		pF
Turn-on Delay Time	t <sub>d(on)</sub>	ID = 35 A		75		ns
Rise Time	tr	V <sub>GS(on)</sub> = 10 V		1150		ns
Turn-off Delay Time	t <sub>d(off)</sub>	VDD = 30 V		360		ns
Fall Time	tf	$R_G = 10 \Omega$		480		ns
Total Gate Charge	Q <sub>G</sub>	ID = 70 A		95		nC
Gate to Source Charge	Qgs	V <sub>DD</sub> = 48 V		13		nC
Gate to Drain Charge	Q <sub>GD</sub>	V <sub>GS(on)</sub> = 10 V		30		nC
Body Diode Forward Voltage	VF(S-D)	IF = 70 A, VGS = 0 V		0.97		V
Reverse Recovery Time	trr	IF = 70 A, Vgs = 0 V		70		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		140		nC

#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**





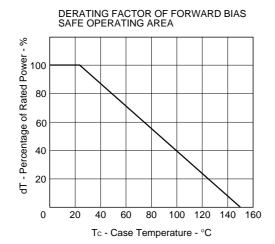
#### **TEST CIRCUIT 2 SWITCHING TIME**

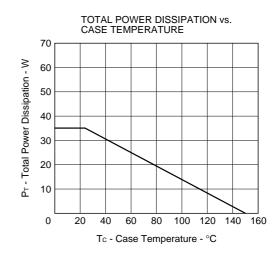


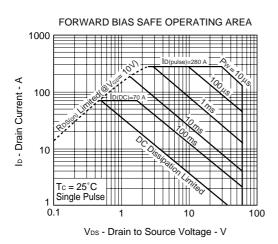
#### **TEST CIRCUIT 3 GATE CHARGE**

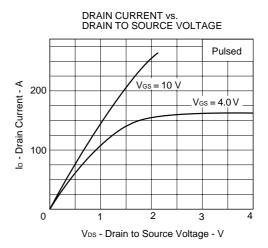


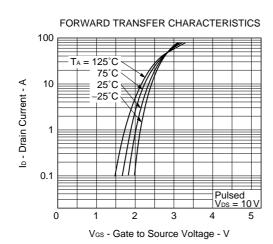
### TYPICAL CHARACTERISTICS (TA = 25 °C)





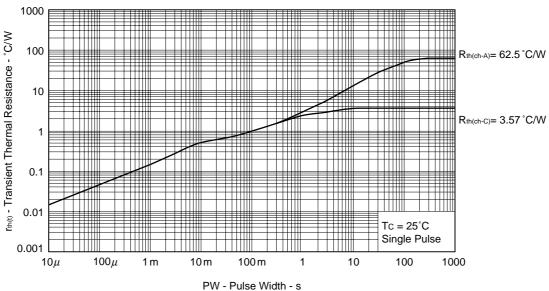




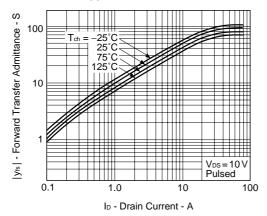


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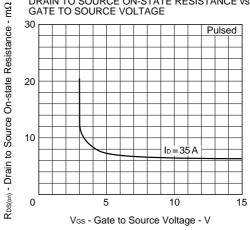
#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



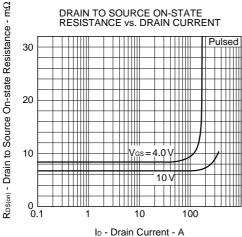
## FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

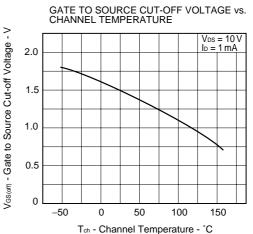


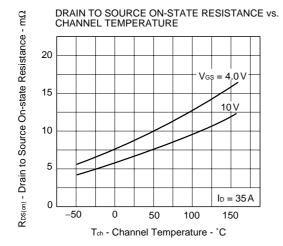
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

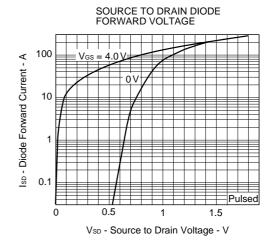


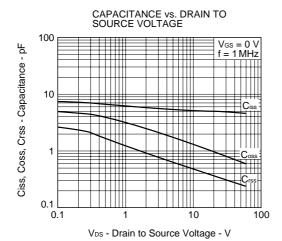
### DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT 30

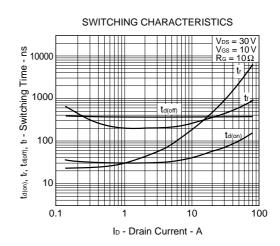


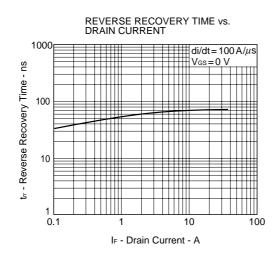


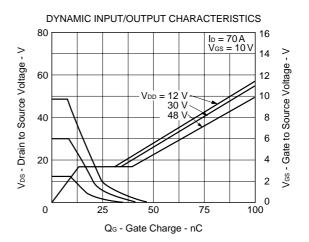


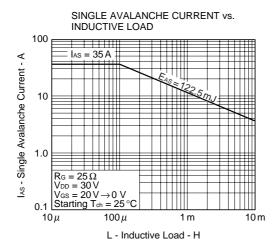


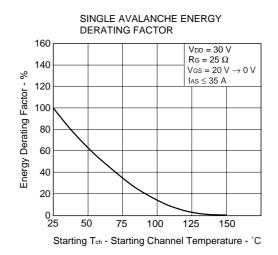






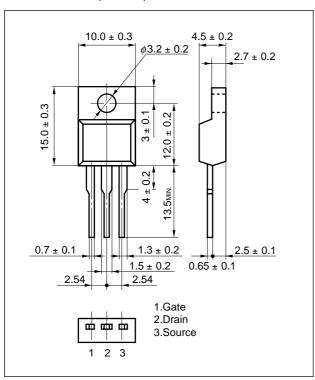




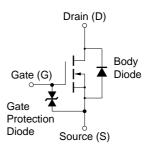


#### PACKAGE DRAWING (Unit: mm)

#### Isolated TO-220 (MP-45F)



#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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